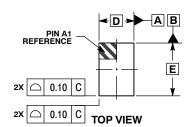
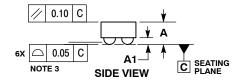
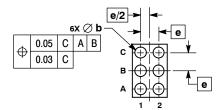


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DATE 28 MAY 2013

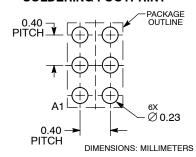






BOTTOM VIEW

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

	MILLIMETERS		
DIM	MIN	IIN MAX	
Α		0.50	
A1	0.13	0.17	
b	0.21	0.25	
D	0.77 BSC		
E	1.17 BSC		
е	0.40	BSC	

GENERIC MARKING DIAGRAM*



XX = Specific Device Code

= Date Code Μ

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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